ASSOCIATION CONNECTIN ELECTRONICS INDUSTRIE	Material Composition © Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docum level parts, t	ent is a declara the declaration	tion of the sencompasse	substances es all lowe	within the manufactu r level materials for w	rer listed	item. Note: it nanufacturer	f the item is an as has engineering	ssembly with lower responsibility.	
1752-21.1					Form Type Distribute	 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater 					ials and Mfg Information				
Supplier Inform	ation														
Company name*			Company unique ID				Unique ID Authority					Response Date*			
onsemi										2024-05-20					
Contact Name		Title - Contact				Phone - Contact*				Email -	Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requeste	er Item Number			r Mfr Item Name			Effective Dat	e Version	1	Manufacturing Site		Weight*	UOM	Unit Type	
		MMSZ5225BT1G Z		ZEN SOD123 REG 0.5W 3.0V			2024-05-20		(CN1		11.525	mg	Each	
Manufacturing	Proccess Information	1													
Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body Temperature		re Max Time at Peak	Tempera	ture Numb	er of Reflow Cy	cles			
Matte Tin (Sn) - annealed C			U Alloy 1			260 C		C	30	seco	nds 3				
Comments															
evel 1 - maximum t	ime at peak temperature o	luring sol	dering is 10-3	0 seconds											
or more informati	on regarding material con	position	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.88	mg	Supplier	Silicon (Si)	7440-21-3		0.88	mg
Lead Frame	3.19	mg	В	Nickel (Ni)	7440-02-0		1.158	mg
			Supplier	Iron (Fe)	7439-89-6		1.6014	mg
			Supplier	Copper (Cu)	7440-50-8		0.4306	mg
Mold Compound-Black	6.51	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.651	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0325	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.9439	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.2315	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.651	mg
Plating	0.8	mg	Supplier	Tin (Sn)	7440-31-5		0.8	mg
Wire Bond	0.145	mg	Supplier	Palladium (Pd)	7440-05-3		0.0019	mg
			Supplier	Copper (Cu)	7440-50-8		0.1431	mg